







#### Densification mechanisms of metallic systems by SPS at the microscopic scale

Jean-Philippe Monchoux<sup>1</sup>, Zofia Trzaska<sup>2</sup>, Christophe Collard<sup>1</sup>, Lise Durand<sup>1</sup>, Alain Couret<sup>1</sup>, Jean-Marc Chaix<sup>3</sup>, Gilbert Fantozzi<sup>4</sup>, Guillaume Bonnefont<sup>4</sup>

<sup>1</sup>CEMES Toulouse <sup>2</sup>LSPM Villetaneuse <sup>3</sup>SIMAP Grenoble <sup>4</sup>MATEIS INSA Lyon

FIMPART 2017 – Bordeaux, July 9-12



## Outline



Conclusions : microscopic densification mechanisms

#### Conditions

- r / R = 0,04
- E = 15 V/m applied at t=0 (exp. value)
- No heat loss by radiation
- No contact resistances

#### Local equations solved

$$\nabla \cdot (\nabla V) = 0$$
Electricity eq.
$$\nabla \cdot (-\lambda \nabla T) + \rho c_p \left(\frac{\partial T}{\partial t}\right) = \sigma (\nabla V)^2$$
Heat eq.

V : tension (V), T : temperature (K)

Temperature-dependent physical constants of TiAl at 1000°C:

 $\begin{array}{lll} \lambda & : \mbox{thermal conductivity} & 23 \ W.m^{-1}.K^{-1} \\ \sigma & : \mbox{electrical conductivity} & 8,1 \times 10^5.\Omega^{-1}.m^{-1} \\ c_p & : \mbox{thermal capacity} & 693 \ J.kg^{-1}.K^{-1} \\ \rho & : \mbox{density} & 3900 \ kg.m^{-3} \end{array}$ 



#### Current density map



Local current ≈ 100 × average current

#### Current density map

#### Temperature map



#### **Diffusion of heat** generated at hot spots

#### = 0

×10

1.2

1.1 1

0.9 0.8

0.7

0.6 0.5

0.4 0.3



Particles 100 µm in diameter  $\rightarrow$  t  $\approx$  4 ms

Time for homogenize temperature in the particles (at  $\pm 1^{\circ}$ C):



Parabolic law: heat transfer by diffusion

Limited overheating at the necks: fast heat diffusion at the particle scale (100 µm)

Other phenomena induced by high currents at the necks: electroplasticity? electromigration?

Electroplasticity: force exerted by high currents on the dislocations, considered as impenetrable cylinders

#### **Plasticity mechanisms in TiAl**









Screw dislocations anchored on pinning points

Curved dislocations

Glide

Glide + climb

High current  $\rightarrow$  change of mechanism? Ex: activation of cross-slip, of mixed climb,...

#### Identification of the plasticity mechanisms: TEM thin foil lift-out by FIB





TEM images of FIB thin foils

900°C – Center



Microstructure identical to the initial state

TEM images of FIB thin foils

#### 900°C – Center



Microstructure identical to the initial state

900°C – Neck



#### Intense plastic deformation





Climb-controlled glide

EBSD grain size map





Small grains at the necks

 $\downarrow$ 

#### Recrystallization

- Intense plastic deformation by twinning and climb-controlled glide
- Relaxation of deformation by recoveryrecrystallization

Densification by classical metallurgical phenomena

No change of mechanism

Higher kinetics induced by current?

Aim: evaluate the role of the current on densification kinetics

Necessity of identical cycles and sample temperatures

Sample temperature calibration



#### **Presure - temperature cycles**





**Isothermal densification curves** 



TiAl constitutive relation:

$$\dot{\varepsilon} = A_0 \exp\left(-\frac{\boldsymbol{Q}}{RT}\right) \sigma^{\boldsymbol{n}}$$

$$\dot{\varepsilon} = G_1(D)\dot{D}$$

Von Misès stress in the powder particles

 $\sigma = G_2(D)P$ 

$$\ln \dot{D} = f(\ln P) \to \mathbf{n}$$
$$\ln \dot{D} = f\left(\frac{1}{T}\right) \to \mathbf{Q}$$

**Typical values for bulk TiAl** 

#### **Calculation of the densification cycle**

Ashby, Arzt et Helle (1983, 1985)  

$$D < 0.9: \quad \dot{D} = 5.3 (D^2 D_0)^{1/3} \frac{1}{\sqrt{3}} \left( \frac{D - D_0}{1 - D_0} \right)^{1/2} \dot{\varepsilon} \qquad D > 0.9: \quad \dot{D} = \frac{3}{2} \times \frac{D(1 - D)}{[1 - (1 - D)^{1/n}]^n} \dot{\varepsilon}$$



Good reproduction of the anisothermal densification kinetics

## **Densification kinetics – Summary**

- Close densification kinetics by SPS (≈ 100 A/cm<sup>2</sup>) and by HP (0 A/cm<sup>2</sup>)
- Activation energy for densification (≈ 300 kJ/mol) close to that of bulk self diffusion of AI in TiAI (360 kJ/mol, Herzig 1999)
- Anisothermal densification kinetics (100°C/min) well reproduced analytically by Ashby et al's modèle (1983, 1985)

No modification of kinetics by currents  $\approx$  100 A/cm<sup>2</sup>

→ Effect of stronger currents?

# **Electromigration in Ag-Zn**

Electromigration :

Perturbation of the electron flow by the diffusing atoms when they are in the activated state  $\rightarrow$  momentum tranfer

#### Modification of 2nd Fick's law:



Drift with time of the diffusion profile





Friedman et al, Intermetallics 12 (2004) 589

# **Electromigration in Ag-Zn**



Parabolic kinetics

#### **No electromigration**

# Conclusions

#### Mechanisms controlling densification:

Plastic deformation by dislocations followed by recovery/recrystallization Kinetics controlled by AI bulk diffusion

#### • Effect of current?

- Negligible Joule overheating
- Current  $\approx$  100 A/cm<sup>2</sup> : no acceleration of densification
- Current > 500 A/cm<sup>2</sup> : no electromigration in Ag-Zn

SPS conventional conditions



Densification by classical metallurgical mechanisms, without acceleration by the current